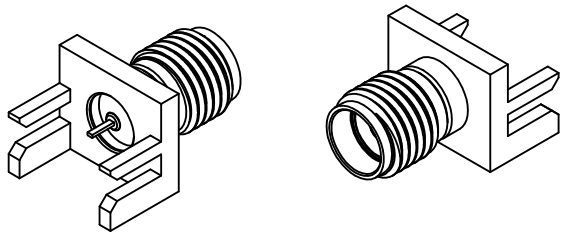
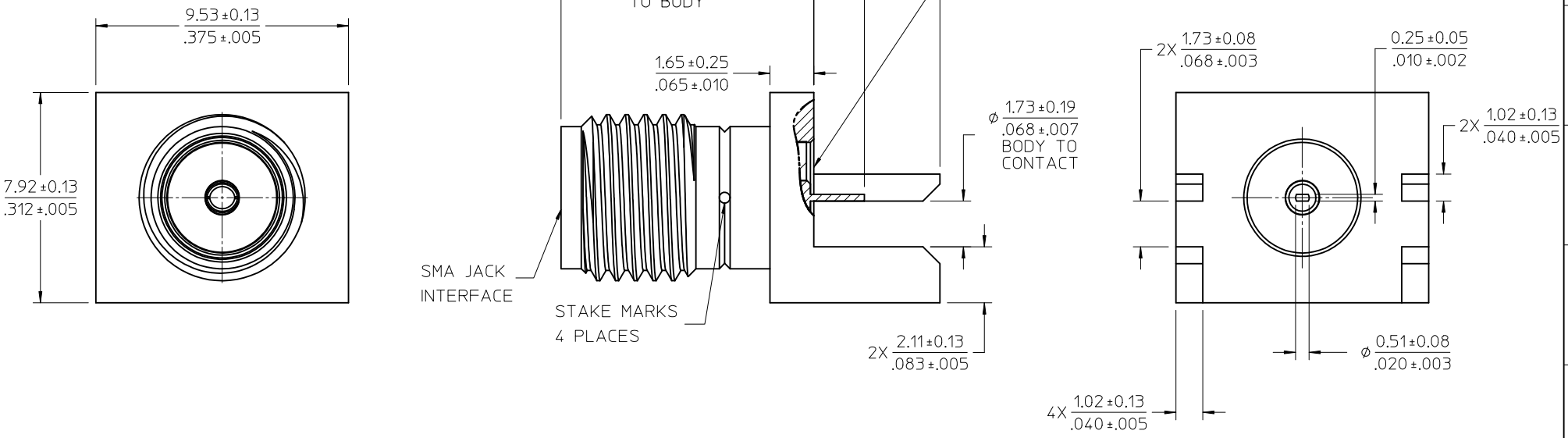
MATERIALS AND FINISHES:

BODY BRASS
FINISH GOLD (10 μ-IN MIN) OVER NICKEL (100 μ-IN MIN) OVER COPPER (50 μ-IN MIN)

CONTACT BERYLLIUM COPPER
FINISH GOLD (10 μ-IN MIN) OVER NICKEL (100 μ-IN MIN) OVER COPPER (50 μ-IN MIN)

INSULATOR TEFLON





CONTACT RETENTION:
AXIAL 26.7 N(6 LB) MIN
TORQUE 2.82 N-cm(4 IN-OZ) MIN

UL File Number E107635

PART # 73251-4440

PS-89675-3460	PRODUCT SPECIFICATION
SPECIFICATION	DESCRIPTION

CHG: NEW RELEASE
EC NO: URF2011-0586 2011/03/30
DRWN:SSHAH 2011/04/07
CH'KD:SSS
APPR: JWIENER 2011/04/11
DESCRIPTION
A
REV

QUALITY SYMBOLS
▼=0
▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± ---	± ---
1 PLACE	± ---	± ---
ANGULAR ± 2 °		

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM/IN
SCALE
DESIGN UNITS: METRIC
THIRD ANGLE PROJECTION

DRAWN BY SSHAH DATE 2011/03/08
CHECKED BY AZR DATE 2011/04/07
APPROVED BY JWIENER DATE 2011/04/11

TITLE: SMA JACK PCB END LAUNCH 50 OHMS TAB CONTACT EWR-4637 SMA-J/PCB

MOLEX INCORPORATED

MATERIAL NO. 732514440
DOCUMENT NO. SD-73251-444
SHEET NO. 1 OF 1
SIZE C

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